	( )	form 1449/PTO			Application Number 10/522,388 U.S. Filing Date: August 26, 2005		
12 S	FP 1 0 2007 🕏 nformation Disclosure				First Named Inventor:	Daniel CIESINGER	
園		Statement E			Art Unit:	2876	
120	(Use as many sheets as necessary)				Examiner Name:	Seung H. Lee	
					Attorney Docket Number:	WACHP005	
	Sheet	1	of	1			

**U.S. Patent Documents** 

O.O. I dient bocaments						
Examiner Initial	Cite No.	Document No.	Publication Date	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, where Relevant Passages or Relevant Figures Appear	
/SL/	Α	4,874,935	10/1989	Younger		
/SL/	В	6,145,080	11/2000	Hänel		
/SL/	С	6,527,190	3/2003	Weinländer		
	D					
	Е	·				
	F					
	G					
	Н					
	I					
	J					
	K					

**Foreign Patent Documents** 

Examiner Initial	Cite No.	Foreign Patent Document No.	Publication Date	Name of Patentee or Applicant of	Pages, Columns, Lines, where Relevant Passages or Relevant	Translation	
				Cited Document	Figures Appear	YES	NO
/SL/	L	EP 0 292 248 A2	11/1988	Steiner et al.			
1	М	DE 197 39 545 C1	1/1999	Weinländer			x
	N	EP 0 361 491 A2	04/1990	Milczewsky			х
/SL/	0	EP 0 361 491 B1	04/1990	Milczewsky		X claims only	
	P						
	Q						

**Non Patent Literature Documents** 

Examiner Initial	Cite No.	Include name of author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.
/SL/	R	W. RANKL et al., "Smart Card Handbook, Third Edition," 1999, pp. 250-281.
/SL/	S	Website content entitled "XML in 10 points," 1999, pp. 1-4 (available at http://www.w3.org/XML/1999/XML-in-10-points.html).
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Examiner Signature	/Seung Lee/	Date Considered	. 09/24/2007

Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.